# 2 Form A 

## FEATURES

- Load Voltage, 15 V
- Load Current, 150 mA
- Switching Capability up to 50 MHz
- Blocking Capability Dependent upon Signal dv/dt
- Low and Typical $R_{\text {ON }} 5.0 \Omega$
- 1.0 ms Actuation Time
- Low Power Consumption
- 3750 V RMS $^{\text {I/O Isolation }}$
- Balanced Switching
- Linear AC/DC Operation
- Clean, Bounce-free Switching
- Surface-mountable


## AGENCY APPROVALS

- UL - File No. E52744
- CSA - Certification 093751
- VDE 0884 Approval


## APPLICATIONS

- Protection Switching (T1 sparing)
- Digital Access Cross Connects
- D-type Channel Breaks
- Intraoffice Data Routing
- Transmission Switching
- T1 Multiplexing
- DSO (64 Kbits/s)
- DS1 (1.544 Mbits/s)
- E1, DS1A (2.048 Mbits/s)
- DS1C (3.152 Mbits/s)
- DS2 (6.312 Mbits/s)
- Instrumentation
- Scanners
- Testers
- Measurement Equipment
- See Application Note


## Part Identification

| Part Number | Description |
| :--- | :--- |
| LH1514AB | 8-pin DIP, Tubes |
| LH1514AAC | 8-pin SMD, Gullwing, Tubes |
| LH1514AACTR | 8-pin SMD, Gullwing, Tape and <br> Reel |



## DESCRIPTION

The LH1514 is a DPST normally open (2 Form A) SSR that can be used in balanced high-frequency applications like T1 switching. With its low ON-resistance and high actuation rate, the LH1514 is also very attractive as a general-purpose 2 Form A SSR for balanced signals.
The relays are constructed using a GaAIAs LED for actuation control and an integrated monolithic die for the switch output. The die, fabricated in a dielectrically isolated Smart Power BiCMOS, is comprised of a photodiode array, switch control circuitry, and NMOS switches.

In balanced switching applications, internal circuitry shunts high-frequency signals between two poles when the SSR is off. This balanced T termination technique provides high isolation for the load.

Recommended Operating Conditions

| Parameter | Sym. | Min. | Typ. | Max. | Unit |
| :--- | :--- | :--- | :--- | :--- | :--- |
| LED Forward <br> Current for Switch <br> Turn-on | $I_{\text {Fon }}$ | 10 | - | 20 | mA |
| $\left(T_{\mathrm{A}}=-40^{\circ} \mathrm{C}\right.$ to <br> $\left.+85^{\circ} \mathrm{C}\right)$ |  |  |  |  |  |

Absolute Maximum Ratings, $T_{\mathrm{A}}=25^{\circ} \mathrm{C}$
Stresses in excess of the Absolute Maximum Ratings can cause permanent damage to the device. These are absolute stress ratings only. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of the data sheet. Exposure to maximum rating conditions for extended periods can adversely affect device reliability.

Ambient Operating Temperature Range, $T_{\mathrm{A}} \ldots \ldots \ldots \ldots \ldots . . . . . . . . . .0^{\circ}$ to $+85^{\circ} \mathrm{C}$ Storage Temperature Range, $T_{\text {stg }} \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots . . . . . . . . . . . . . . . . . . . . ~ 40^{\circ}$ to $+150^{\circ} \mathrm{C}$ Pin Soldering Temperature, $\mathrm{t}=10 \mathrm{~s}$ max, $T_{\mathrm{S}} \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots . . . . . . . . . . . . . . . . .260^{\circ} \mathrm{C}$
 LED Input Ratings:
Continuous Forward Current, $I_{\mathrm{F}}$............................................... 50 mA

Output Operation:
dc or Peak ac Load Voltage, $I_{\mathrm{L}} \leq 1.0 \mu \mathrm{~A}, V_{\mathrm{L}} \ldots \ldots . . . . . . . . . . . . . . . . . . . . . . . . . . . . ~ 15 \mathrm{~V}$
Continuous dc Load Current, $I_{\mathrm{L}}$
Each Pole, Two Poles Operating Simultaneously ................. 150 mA
Power Dissipation, $P_{\text {DISS }}$. 600 mW

## Electrical Characteristics, $T_{\mathrm{A}}=25^{\circ} \mathrm{C}$

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information purposes only and are not part of the testing requirements.

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Test Condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| LED Forward Current, Switch Turn-on | $I_{\text {Fon }}$ | - | 2.0 | 5.0 | mA | $I_{\mathrm{L}}=100 \mathrm{~mA}, \mathrm{t}=10 \mathrm{~ms}$ |
| LED Forward Current, Switch Turn-off | $I_{\text {Foff }}$ | 0.2 | 1.8 | - | mA | $V_{\mathrm{L}}= \pm 10 \mathrm{~V}$ |
| LED Forward Voltage | $V_{F}$ | 1.15 | 1.26 | 1.45 | V | $I_{\mathrm{F}}=10 \mathrm{~mA}$ |
| ON-resistance | $R_{\text {ON }}$ | 2.0 | 3.0 | 5.0 | $\Omega$ | $I_{\mathrm{F}}=10 \mathrm{~mA}, I_{\mathrm{L}}= \pm 50 \mathrm{~mA}$ |
| Pole-to-pole ON-resistance Matching (S1 to S2) | - | - | 0.2 | 1.0 | $\mathrm{D} \Omega$ | $I_{\mathrm{F}}=10 \mathrm{~mA}, I_{\mathrm{L}}= \pm 50 \mathrm{~mA}$ |
| Output Off-state Bleed-through* | - | - | 70 | 100 | mV peak | $\mathrm{f}=1.5 \mathrm{MHz}$ square wave $\mathrm{t}_{\mathrm{r}} / \mathrm{t}_{\mathrm{f}}=5.0 \mathrm{~ns}$ (See Figure 13.) |
| Output Off-state Leakage | - | - | $\begin{aligned} & 3 \times 10^{-12} \\ & 20 \times 10^{-12} \end{aligned}$ | $\begin{aligned} & 200 \times 10^{-9} \\ & 1.0 \times 10^{-6} \end{aligned}$ | A | $\begin{aligned} & I_{\mathrm{F}}=0 \mathrm{~mA}, V_{\mathrm{L}}= \pm 5.0 \mathrm{~V} \\ & V_{\mathrm{L}}= \pm 15 \mathrm{~V} \end{aligned}$ |
| Output Off-state Leakage Pole to Pole | - | - | 1.0 | 5.0 | $\mu \mathrm{A}$ | $\begin{aligned} & I_{\mathrm{F}}=10 \mathrm{~mA} \\ & \text { Pins 7, } 8 \pm 3.0 \mathrm{~V} \\ & \text { Pins 5, } 6 \text { Gnd } \end{aligned}$ |
|  |  | - | 2.0 | 50 | $\mu \mathrm{A}$ | Pins $7,8 \pm 15 \mathrm{~V}$ Pins 5, 6 Gnd |
| Output Capacitance Pins 5 to 6, 7 to 8 | - | - | 20 | - | pF | $I_{\mathrm{F}}=0 \mathrm{~mA}, V_{\mathrm{L}}=0$ |
| Pole-to-pole Capacitance (S1 to S2) | - | - | $\begin{aligned} & 20 \\ & 50 \end{aligned}$ | - | $\begin{aligned} & \mathrm{pF} \\ & \mathrm{pF} \end{aligned}$ | $\begin{aligned} & I_{\mathrm{F}}=0 \mathrm{~mA}, V_{\mathrm{L}}=0 \mathrm{~V} \\ & I_{\mathrm{F}}=10 \mathrm{~mA}, V_{\mathrm{L}}=0 \mathrm{~V} \end{aligned}$ |
| Turn-on Time | $t_{\text {on }}$ | - | 0.4 | 1.0 | ms | $I_{\mathrm{F}}=10 \mathrm{~mA}, I_{\mathrm{L}}=20 \mathrm{~mA}$ |
| Turn-off Time | $t_{\text {off }}$ | - | 0.6 | 1.0 | ms | $I_{\mathrm{F}}=10 \mathrm{~mA}, I_{\mathrm{L}}=20 \mathrm{~mA}$ |

* Guaranteed by component measurement during wafer probe.


## Typical Performance Characteristics

Figure 1. LED Forward Current for Switch Turn-on/off


Figure 2. Leakage Current vs. Applied Voltage


Figure 3. ON-Resistance vs. Temperature


Figure 4. Breakdown Voltage Distribution Typical


Figure 5. Output Isolation


Figure 6. Insertion Loss (per Pole) vs. Frequency


Figure 7. $t_{\text {on }}$ vs. LED Forward Current


Figure 8. Bleed-through Voltage vs. Rise Time


Figure 9. $t_{\text {on }} t_{\text {off }}$ vs. Temperature


Figure 10. $t_{\text {off }}$ vs. LED Forward Current


## Functional Description

Figure 12 shows the switch characteristics of the relay. The relay exhibits an ON-resistance that is exceptionally linear up to the knee current $\left(I_{\mathrm{K}}\right)$. Beyond $I_{\mathrm{K}}$, the incremental resistance decreases, minimizing internal power dissipation.

In a 2 Form A relay, to turn the relay on, forward current is applied to the LED. The amount of current applied determines the amount of light produced for the photodiode array.

This photodiode array develops a drive voltage for both NMOS switch outputs. For high-temperature or high-load current operations, more LED current is required.

For high-frequency applications, the LH1514 must be wired as shown in the Figure 15 application diagram to minimize transmission crosstalk and bleed-through. A single LH1514 package switches a single transmit twisted pair or a single receive twisted pair. In this configuration when the SSR is turned off, the SSR parries high-frequency signals by shunting them through the SSR, thereby isolating the transformer load.

When switching alternate mark inversion (AMI) coding transmission, the most critical SSR parameter is dv/dt bleedthrough. This bleed-through is a result of the rise and fall time slew rates of the 3.0 V AMI pulses. The test circuit in Figure 13 illustrates these bleed-through glitches. It is important to recognize that the transmission limitations of the LH1514 are bleed-through related and not frequency related. The maximum frequency the LH1514 SSR can switch will be determined by the pulse rise and fall times and the sensitivity of the receive electronics to the resultant bleed-through.
At data rates above 2.0 Mbits/s, the 50 pF pole-to-pole capacitance of the LH1514 should be considered when analyzing the load match to the transmission line. Please refer to the T1 Switching with the LH1514 SSR Application Note for further information on load-matching and off-state blocking.

Figure 11. Pin Diagram and Pin Outs


Figure 12. Typical ON Characteristics


## Test Circuit

Figure 13. Off-state Bleed-through


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## Applications

Figure 14. Protection Switching Application: T1 Interface Operating; Spare in Test Loopback Mode


Figure 15. T1 Multiplexer Receive Data (Interface 1, Operating) Features



[^0]:    * $50 \Omega$ load is derived from T1 applications where a $100 \Omega$ load is paralleled with a $100 \Omega$ line.

